

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MACIEJ DZIEDZIELA	08/25/2017
RECEIVING PARTY DATA	
Name:	VID INC.
Street Address:	11755 WILSHIRE BLVD.
Internal Address:	SUITE 1250, #403
City:	LOS ANGELES
State/Country:	CALIFORNIA
Postal Code:	90025
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15686842
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	HAUG PARTNERS LLP
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Address Line 4:	NEW YORK, NEW YORK 10151
ATTORNEY DOCKET NUMBER:	A251-1
NAME OF SUBMITTER:	XUEZHENG WANG
SIGNATURE:	/Xuezheng Wang/
DATE SIGNED:	02/05/2018
Total Attachments: 1	
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ASSIGNMENT

WHEREAS, I, as below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

SYSTEM AND METHOD FOR COMBINING AUDIO TRACKS WITH VIDEO FILES

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address.

AND WHEREAS, Vid Inc., with offices in 11755 Wilshire Blvd., Suite 1250, 4003, Los Angeles, California, 90025 (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries.

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any, and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing in or accruing to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest therein.

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign therein;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and in, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense.

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any proceeding in front of a patent office or litigation related thereto.

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorneys of record in this application to insert the serial number and filing date of this application in the spaces that follow: U.S. Application Serial Number _____ Filing Date _____

This assignment executed on the dates indicated below

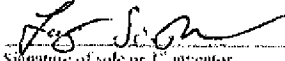
Jagpal Singh

Name of sole or 1st inventor

Execution date of U.S. Patent Application

Worcester, UK

Residence of sole or 1st inventor



Signature of sole or 1st inventor

08/25/2017

Date of this assignment

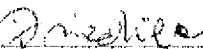
Maciej Dzieciela

Name of sole or 2nd inventor

Execution date of U.S. Patent Application

Hertfordshire, U.K.

Residence of sole or 2nd inventor



Signature of sole or 2nd inventor

08/25/2017

Date of this assignment